

PBSS4230PANP

30 V, 2 A NPN/PNP low VCEsat (BISS) transistor 14 December 2012

Product data sheet

General description 1.

NPN/PNP low V_{CFsat} Breakthrough In Small Signal (BISS) transistor in a leadless medium power DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package.

NPN/NPN complement: PBSS4230PAN. PNP/PNP complement: PBSS5230PAP.

2. **Features and benefits**

- Very low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain h_{FE} at high I_C
- Reduced Printed-Circuit Board (PCB) requirements
- High efficiency due to less heat generation
- AEC-Q101 qualified

Applications

- Load switch
- Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transisto	or; for the PNP transistor	with negative polarity				
V _{CEO}	collector-emitter voltage	open base	-	-	30	V
I _C	collector current		-	-	2	Α
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms	-	-	3	Α
TR1 (NPN)						_
R _{CEsat}	collector-emitter saturation resistance	I_{C} = 1 A; I_{B} = 100 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	-	-	145	mΩ



Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR2 (PNP)						
R _{CEsat}	collector-emitter saturation resistance	I_C = -1 A; I_B = -100 mA; pulsed; $t_p \le 300$ μs; $\delta \le 0.02$; T_{amb} = 25 °C	-	-	195	mΩ

5. Pinning information

Table 2. Pinning information

1 E1 emitter TR1 2 B1 base TR1 3 C2 collector TR2 4 E2 emitter TR2 5 B2 base TR2 Transparent top view		9			
2 B1 base TR1 3 C2 collector TR2 4 E2 emitter TR2 5 B2 base TR2 6 C1 collector TR1 7 C1 collector TR1 DFN2020-6 (SOT1118)	Pin	Symbol	Description	Simplified outline	Graphic symbol
3	1	E1	emitter TR1	6 5 4	C1 B2 E2
3	2	B1	base TR1		
5 B2 base TR2 6 C1 collector TR1 7 C1 collector TR1 DFN2020-6 (SOT1118)	3	C2	collector TR2	7 8	
5 B2 base TR2 6 C1 collector TR1 7 C1 collector TR1 DFN2020-6 (SOT1118)	4	E2	emitter TR2		
6 C1 collector TR1 7 C1 collector TR1 DFN2020-6 (SOT1118)	5	B2	base TR2		
7 C1 collector TR1	6	C1	collector TR1	' '	sym139
8 C2 collector TR2	7	C1	collector TR1	DI 142020-0 (3011110)	
	8	C2	collector TR2		

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PBSS4230PANP	DFN2020-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body 2 x 2 x 0.65 mm	SOT1118			

7. Marking

Table 4. Marking codes

Type number	Marking code
PBSS4230PANP	2J

8. Limiting values

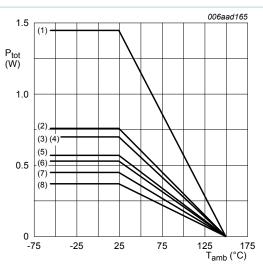
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per transisto	or; for the PNP transistor with n	egative polarity			
V _{CBO}	collector-base voltage	open emitter	-	30	V
V _{CEO}	collector-emitter voltage	open base	-	30	V
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Symbol	Parameter	Conditions		Min	Max	Unit
V_{EBO}	emitter-base voltage	open collector		-	7	V
I _C	collector current			-	2	Α
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	3	Α
I _B	base current			-	0.3	Α
I _{BM}	peak base current	single pulse; t _p ≤ 1 ms		-	1	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	370	mW
			[2]	-	570	mW
			[3]	-	530	mW
			[4]	-	700	mW
			[5]	-	450	mW
			[6]	-	760	mW
			[7]	-	700	mW
			[8]	-	1450	mW
Per device						_
P_{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	510	mW
			[2]	-	780	mW
			[3]	-	730	mW
			[4]	-	960	mW
			[5]	-	620	mW
			[6]	-	1040	mW
			[7]	-	960	mW
			[8]	-	2000	mW
Тj	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

- [1] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided 35 μm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.
- Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.
- 6] Device mounted on an FR4 PCB, single-sided 70 μm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.
- [8] Device mounted on 4-layer PCB 70 μm copper strip line, tin-plated, mounting pad for collector 1 cm².



- (1) 4-layer PCB 70 μm, mounting pad for collector 1 cm²
- (2) FR4 PCB 70 µm, mounting pad for collector 1 cm²
- (3) 4-layer PCB 70 µm, standard footprint
- (4) 4-layer PCB 35 μm, mounting pad for collector 1 cm²
- (5) FR4 PCB 35 μm , mounting pad for collector 1 cm²
- (6) 4-layer PCB 35 µm, standard footprint
- (7) FR4 PCB 70 µm, standard footprint
- (8) FR4 PCB 35 µm, standard footprint

Fig. 1. Per transistor: power derating curves

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transisto	or						,
R _{th(j-a)}	thermal resistance	in free air	[1]	-	-	338	K/W
	from junction to ambient		[2]	-	-	219	K/W
	ambient		[3]	-	-	236	K/W
			[4]	-	-	179	K/W
		[5]	-	-	278	K/W	
		[6]	-	-	164	K/W	
			[7]	-	-	179	K/W
			[8]	-	-	86	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	30	K/W

Symbol	Parameter	Conditions		Min	Тур	Max	Unit		
Per device			,		'		,		
R _{th(j-a)} thermal resistance from junction to ambient	in free air	[1]	-	-	245	K/W			
		[2]	-	-	160	K/W			
	ambient	ambient	[3]	-	-	171	K/W		
					[4]	-	-	130	K/W
			[5]	-	-	202	K/W		
			[6]	-	-	120	K/W		
				[7]	-	-	130	K/W	
			[8]	-	-	63	K/W		

- [1] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.
- [4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.
- [6] Device mounted on an FR4 PCB, single-sided 70 μm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.
- [8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

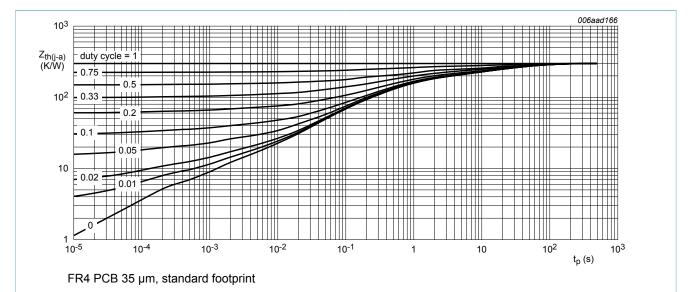
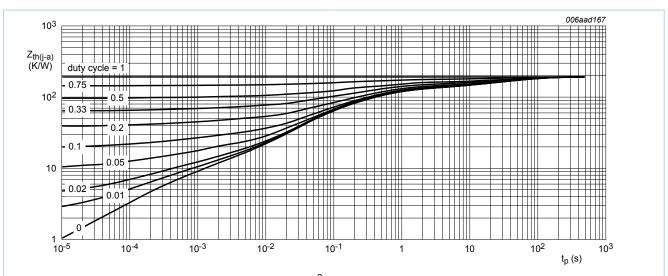
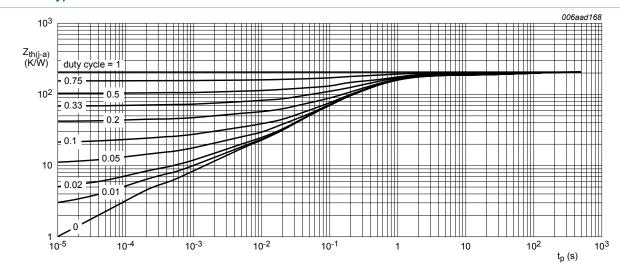


Fig. 2. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB 35 µm, mounting pad for collector 1 cm²

Fig. 3. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values



4-layer PCB 35 µm, standard footprint

Fig. 4. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

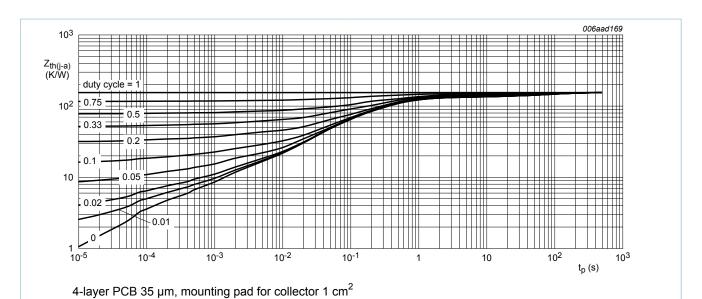


Fig. 5. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

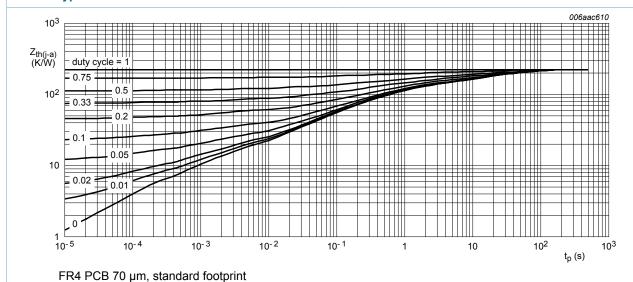


Fig. 6. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

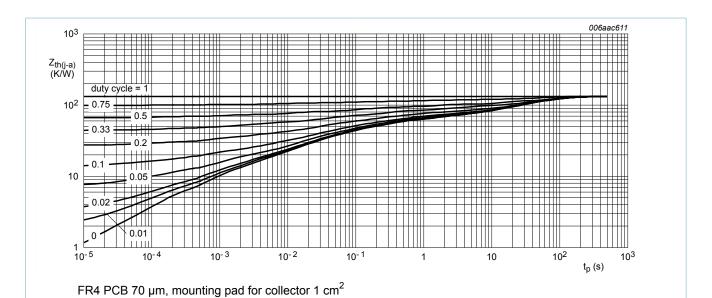


Fig. 7. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

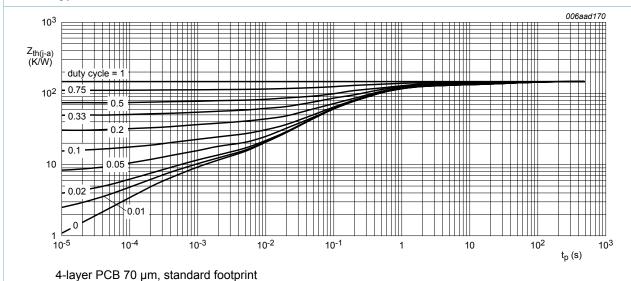


Fig. 8 Por transistor: transient thermal impedance from junction to ambie

Fig. 8. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

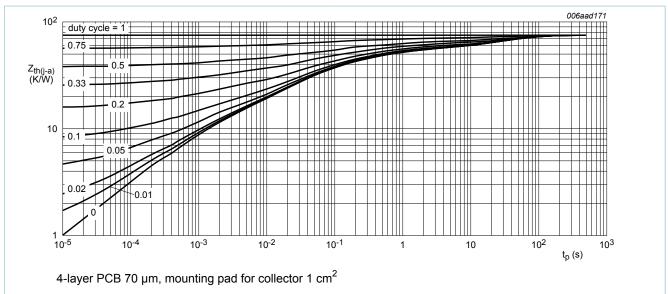


Fig. 9. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (NPN)	'					
I _{CBO}	collector-base cut-off	V _{CB} = 24 V; I _E = 0 A; T _{amb} = 25 °C	-	-	100 50 100 - - - - 80 160	nA
	current	V _{CB} = 24 V; I _E = 0 A; T _j = 150 °C	-	-		μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A; T _{amb} = 25 °C	-	-	100	nA
h _{FE}	DC current gain	V_{CE} = 2 V; I_{C} = 100 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; \ T_{amb}$ = 25 °C	250	380) -	
		V_{CE} = 2 V; I_{C} = 500 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	230	350	-	
		V_{CE} = 2 V; I_{C} = 1 A; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02 ; T_{amb} = 25 °C	200	310	-	
		V_{CE} = 2 V; I_{C} = 2 A; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02 ; T_{amb} = 25 °C	150	230	-	
V _{CEsat}	collector-emitter	I_C = 500 mA; I_B = 50 mA; T_{amb} = 25 °C	-	60	- 50 - 100 380 - 350 - 310 -	mV
	saturation voltage	I_{C} = 1 A; I_{B} = 50 mA; pulsed; $t_{p} \le 300 \ \mu s$; $\delta \le 0.02$; T_{amb} = 25 °C	-	120		mV
		I_{C} = 2 A; I_{B} = 100 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	-	230		mV
		I_C = 2 A; I_B = 200 mA; pulsed; $t_p \le 300 \ \mu s; \ \delta \le 0.02 ; T_{amb}$ = 25 °C	-	220	290	mV

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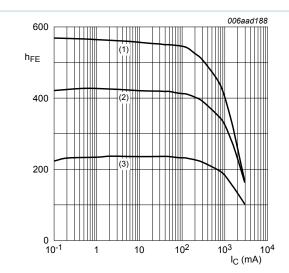
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{CEsat}	collector-emitter saturation resistance	I_{C} = 1 A; I_{B} = 100 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; \ T_{amb}$ = 25 °C	-	-	145	mΩ
V _{BEsat}	base-emitter saturation	I_C = 500 mA; I_B = 50 mA; T_{amb} = 25 °C	-	-	1	V
	voltage	I_{C} = 1 A; I_{B} = 50 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; \ T_{amb}$ = 25 °C	-	-	145	V
		I_{C} = 2 A; I_{B} = 100 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	-	-	1.1	V
		I_{C} = 2 A; I_{B} = 200 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; \ T_{amb}$ = 25 °C	-	-	145 1 1 1.1 1.2 0.9	V
V_{BEon}	base-emitter turn-on voltage	V_{CE} = 2 V; I_{C} = 0.5 A; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	-	-	0.9	V
t _d	delay time	V _{CC} = 12.5 V; I _C = 1 A; I _{Bon} = 50 mA;	-	10	-	ns
t _r	rise time	I _{Boff} = -50 mA; T _{amb} = 25 °C	-	50	-	ns
t _{on}	turn-on time		-	60	-	ns
t _s	storage time		-	310	-	ns
t _f	fall time		-	60	-	ns
t _{off}	turn-off time		-	370	-	ns
f _T	transition frequency	V _{CE} = 10 V; I _C = 50 mA; f = 100 MHz; T _{amb} = 25 °C	60	120	-	MHz
C _c	collector capacitance	V _{CB} = 10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	13.5	18	pF
TR2 (PNP)			l			
I _{CBO}	collector-base cut-off	V _{CB} = -24 V; I _E = 0 A	-	-	-100	nA
	current	V _{CB} = -24 V; I _E = 0 A; T _j = 150 °C	-	-	-50	μA
I _{EBO}	emitter-base cut-off current	V _{EB} = -5 V; I _C = 0 A	-	-	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V; } I_{C} = -100 \text{ mA; pulsed;}$ $t_{p} \le 300 \text{ µs; } \delta \le 0.02 \text{ ; } T_{amb} = 25 \text{ °C}$	260	370	1 1 1 1.1 1.2 0.9 18 - 100 - 50 - 100	
		V_{CE} = -2 V; I_{C} = -500 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 ; T_{amb}$ = 25 °C	210	290	-	
		V_{CE} = -2 V; I_{C} = -1 A; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	160	230	-	
		V_{CE} = -2 V; I_{C} = -2 A; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	100	145	-	
V _{CEsat}	collector-emitter saturation voltage	I_{C} = -500 mA; I_{B} = -50 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	-	-75	-110	mV
		$I_C = -1 \text{ A; } I_B = -50 \text{ mA; pulsed;}$ $t_0 \le 300 \text{ µs; } \delta \le 0.02 \text{ ; } T_{amb} = 25 \text{ °C}$	-	-155	50 100 370 - 290 - 230 - 145 - -75 -110	mV

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		I_{C} = -2 A; I_{B} = -100 mA; pulsed; $t_{p} \le 300 \ \mu s$; $\delta \le 0.02$; T_{amb} = 25 °C	-	-295	-420	mV
		I_{C} = -2 A; I_{B} = -200 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 ; T_{amb}$ = 25 °C	-	-275	-390	mV
R _{CEsat}	collector-emitter saturation resistance	I_{C} = -1 A; I_{B} = -100 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 ; T_{amb}$ = 25 °C	-	-	195	mΩ
V _{BEsat}	base-emitter saturation voltage	I_{C} = -500 mA; I_{B} = -50 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 ; T_{amb}$ = 25 °C	-	-	-1	V
		I_{C} = -1 A; I_{B} = -50 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	-	-	-1	V
		I_{C} = -2 A; I_{B} = -100 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 ; T_{amb}$ = 25 °C	-	-	-1.1	V
		I_{C} = -2 A; I_{B} = -200 mA; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 \ ; T_{amb}$ = 25 °C	-	1.2	V	
V_{BEon}	base-emitter turn-on voltage	V_{CE} = -2 V; I_{C} = -0.5 A; pulsed; $t_{p} \le 300 \ \mu s; \ \delta \le 0.02 ; T_{amb}$ = 25 °C	-	-	-0.9	V
t _d	delay time	V _{CC} = -12.5 V; I _C = -1 A; I _{Bon} = -0.05 A;	-	10	-	ns
t _r	rise time	$\begin{split} &t_p \leq 300 \; \mu s; \delta \leq 0.02 \; ; T_{amb} = 25 \; ^{\circ}C \\ &l_C = -1 \; A; l_B = -100 \; mA; pulsed; \\ &t_p \leq 300 \; \mu s; \delta \leq 0.02 \; ; T_{amb} = 25 \; ^{\circ}C \\ &l_C = -500 \; mA; l_B = -50 \; mA; pulsed; \\ &t_p \leq 300 \; \mu s; \delta \leq 0.02 \; ; T_{amb} = 25 \; ^{\circ}C \\ &l_C = -1 \; A; l_B = -50 \; mA; pulsed; \\ &t_p \leq 300 \; \mu s; \delta \leq 0.02 \; ; T_{amb} = 25 \; ^{\circ}C \\ &l_C = -2 \; A; l_B = -100 \; mA; pulsed; \\ &t_p \leq 300 \; \mu s; \delta \leq 0.02 \; ; T_{amb} = 25 \; ^{\circ}C \\ &l_C = -2 \; A; l_B = -200 \; mA; pulsed; \\ &t_p \leq 300 \; \mu s; \delta \leq 0.02 \; ; T_{amb} = 25 \; ^{\circ}C \\ &V_{CE} = -2 \; V; l_C = -0.5 \; A; pulsed; \\ &t_p \leq 300 \; \mu s; \delta \leq 0.02 \; ; T_{amb} = 25 \; ^{\circ}C \\ &V_{CE} = -12.5 \; V; l_C = -1 \; A; l_{Bon} = -0.05 \; A; \\ &l_{Boff} = 0.05 \; A; T_{amb} = 25 \; ^{\circ}C \\ &V_{CE} = -10 \; V; l_C = -50 \; mA; f = 100 \; MHz; \\ &T_{amb} = 25 \; ^{\circ}C \\ &V_{CB} = -10 \; V; l_E = 0 \; A; i_e = 0 \; A; \\ &V_{CB} = -10 \; V; l_E = 0 \; A; i_e = 0 \; A; \\ &V_{CB} = -10 \; V; l_E = 0 \; A; i_e = 0 \; A; \\ &V_{CB} = -10 \; V; l_E = 0 \; A; i_e = 0 \; A; \\ &V_{CB} = -10 \; V; l_C = -0.50 \; mA; i_e = 0 \; A; \\ &V_{CB} = -10 \; V; l_C = -0.50 \; mA; i_e = 0 \; A; \\ &V_{CB} = -10 \; V; l_C = -0.50 \; mA; i_e = 0 \; A; \\ &V_{CB} = -10 \; V; l_C = -0.50 \; mA; i_e = 0 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; V_{CB} = -0.05 \; A; \\ &V_$	-	50	-	ns
t _{on}	turn-on time		-	60	-	ns
t _s	storage time		-	200	-	ns
t _f	fall time		-	45	-	ns
t _{off}	turn-off time		-	245	-	ns
f _T	transition frequency	V_{CE} = -10 V; I_{C} = -50 mA; f = 100 MHz; T_{amb} = 25 °C	50	95	-	MHz
C _c	collector capacitance	V_{CB} = -10 V; I_{E} = 0 A; i_{e} = 0 A; f_{e} = 1 MHz; f_{amb} = 25 °C	-	22	29	pF



$$V_{CE} = 2 V$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55$$
 °C

Fig. 10. TR1 (NPN): DC current gain as a function of collector current; typical values

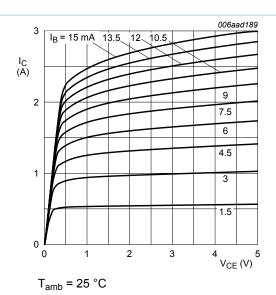
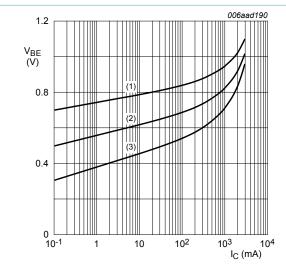


Fig. 11. TR1 (NPN): Collector current as a function of collector-emitter voltage; typical values



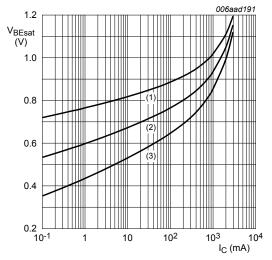
$$V_{CE} = 2 V$$

(1)
$$T_{amb} = -55 \,^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

Fig. 12. TR1 (NPN): Base-emitter voltage as a function of collector current; typical values



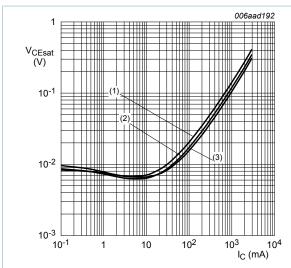
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

Fig. 13. TR1 (NPN): Base-emitter saturation voltage as a function of collector current; typical values



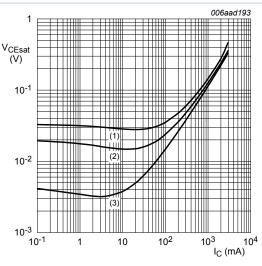
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

$$(3) T_{amb} = -55 °C$$

Fig. 14. TR1 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values



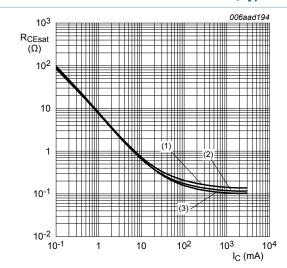
$$T_{amb}$$
 = 25 °C

(1)
$$I_C/I_B = 100$$

(2)
$$I_C/I_B = 50$$

(3)
$$I_C/I_B = 10$$

Fig. 15. TR1 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values



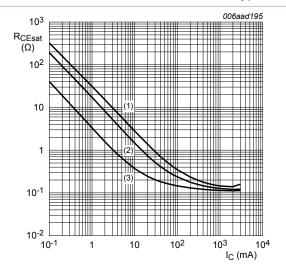
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig. 16. TR1 (NPN): Collector-emitter saturation resistance as a function of collector current; typical values



$$T_{amb}$$
 = 25 °C

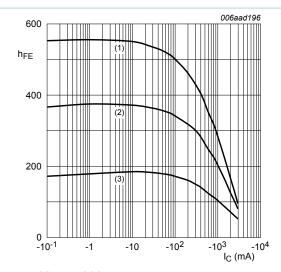
(1)
$$I_C/I_B = 100$$

(2)
$$I_C/I_B = 50$$

(3)
$$I_C/I_B = 10$$

Fig. 17. TR1 (NPN): Collector-emitter saturation resistance as a function of collector current; typical values

13 / 21



$$V_{CE} = -2 V$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

$$(3) T_{amb} = -55 °C$$

Fig. 18. TR2 (PNP): DC current gain as a function of collector current; typical values

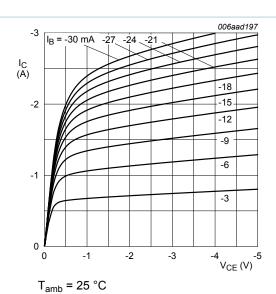
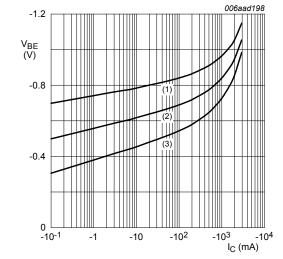


Fig. 19. TR2 (PNP): Collector current as a function of collector-emitter voltage; typical values



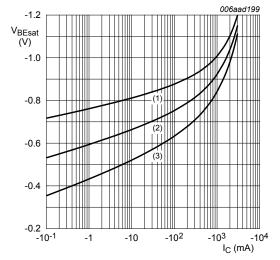
$$V_{CE} = -2 V$$

(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

Fig. 20. TR2 (PNP): Base-emitter voltage as a function of collector current; typical values



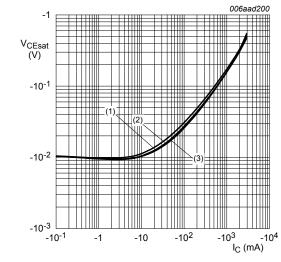
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

Fig. 21. TR2 (PNP): Base-emitter saturation voltage as a function of collector current; typical values



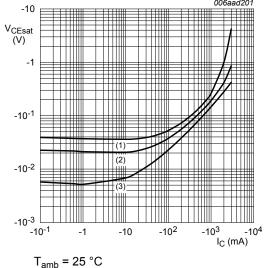
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55$$
 °C

Fig. 22. TR2 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values

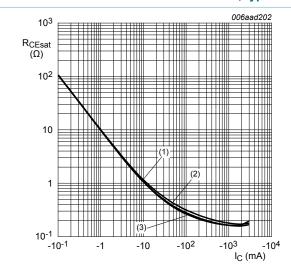


(1)
$$I_C/I_B = 100$$

(2)
$$I_C/I_B = 50$$

(3)
$$I_C/I_B = 10$$

Fig. 23. TR2 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values



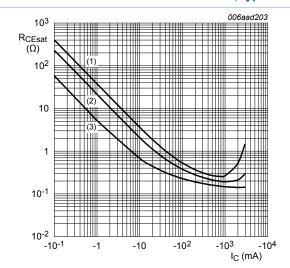
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

$$(3) T_{amb} = -55 °C$$

Fig. 24. TR2 (PNP): Collector-emitter saturation resistance as a function of collector current; typical values



(1)
$$I_C/I_B = 100$$

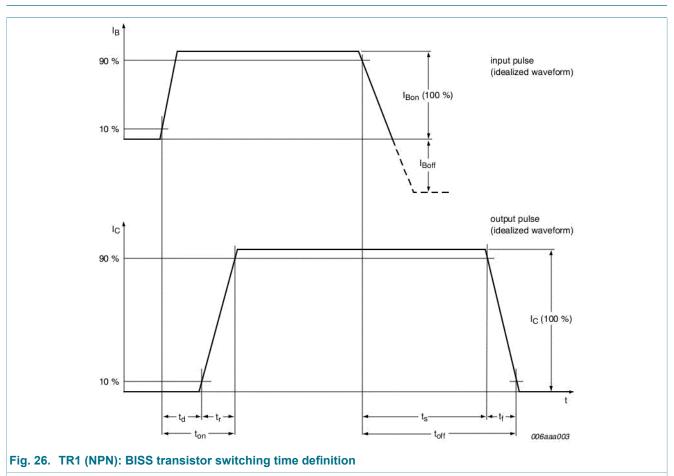
(2)
$$I_C/I_B = 50$$

(3)
$$I_C/I_B = 10$$

Fig. 25. TR2 (PNP): Collector-emitter saturation resistance as a function of collector current; typical values

15 / 21

11. Test information



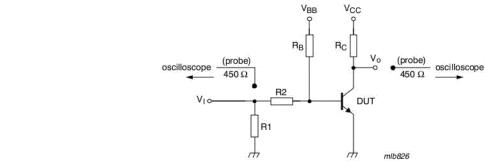
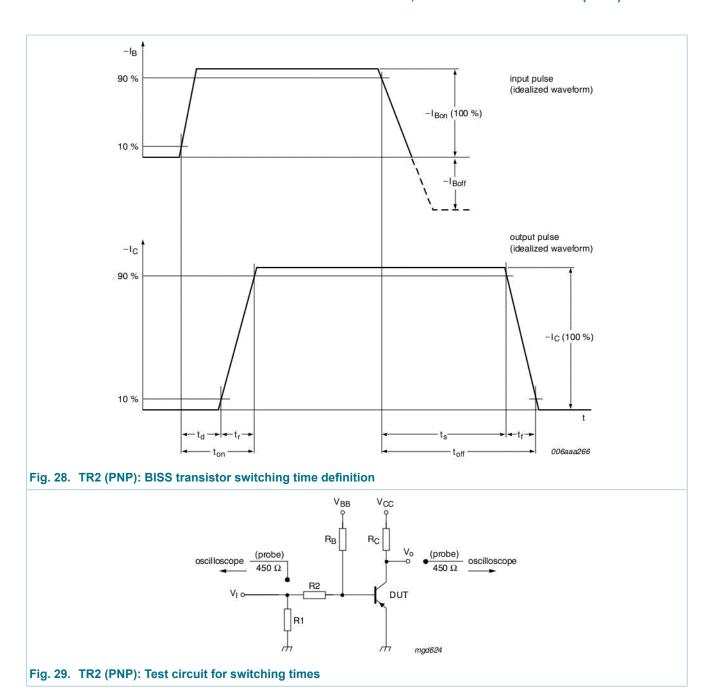


Fig. 27. TR1 (NPN): Test circuit for switching times

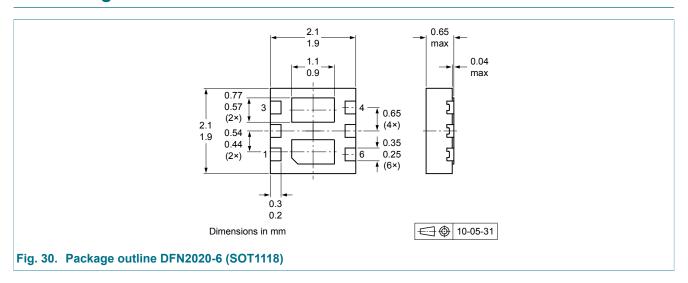


11.1 Quality information

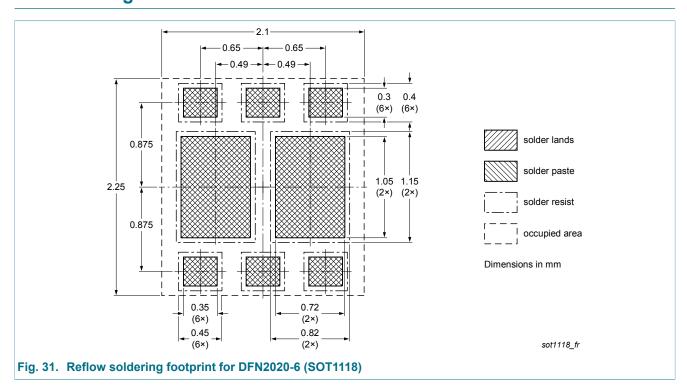
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

17 / 21

12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history

Table of Troviolet motory				
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4230PANP v.1	20121214	Product data sheet	-	-

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Document status [1][2]	Product status [3]	Definition	
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.	
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.	
Product [short] data sheet	Production	This document contains the product specification.	

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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